

HRW0502A

Silicon Schottky Barrier Diode for Rectifying

REJ03G0157-0600Z
(Previous: ADE-208-108E)
Rev.6.00
Jan.06.2004

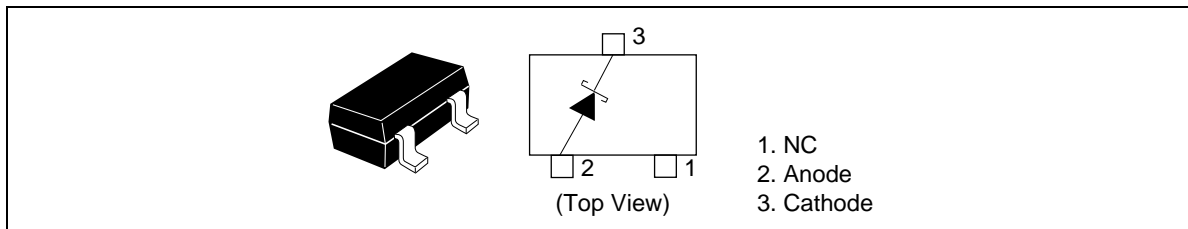
Features

- Low forward voltage drop and suitable for high efficiency rectifying.
- MPAK Package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HRW0502A	S10	MPAK

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Repetitive peak reverse voltage	V_{RRM}^{*1}	20	V
Average rectified current	I_O^{*1}	500	mA
Non-Repetitive peak forward surge current	I_{FSM}^{*2}	5	A
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

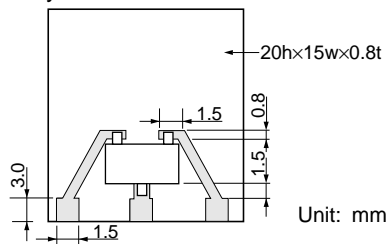
Notes: 1. See from Fig.4 to Fig.6
 2. 10 ms sine wave 1 pulse

Electrical Characteristics

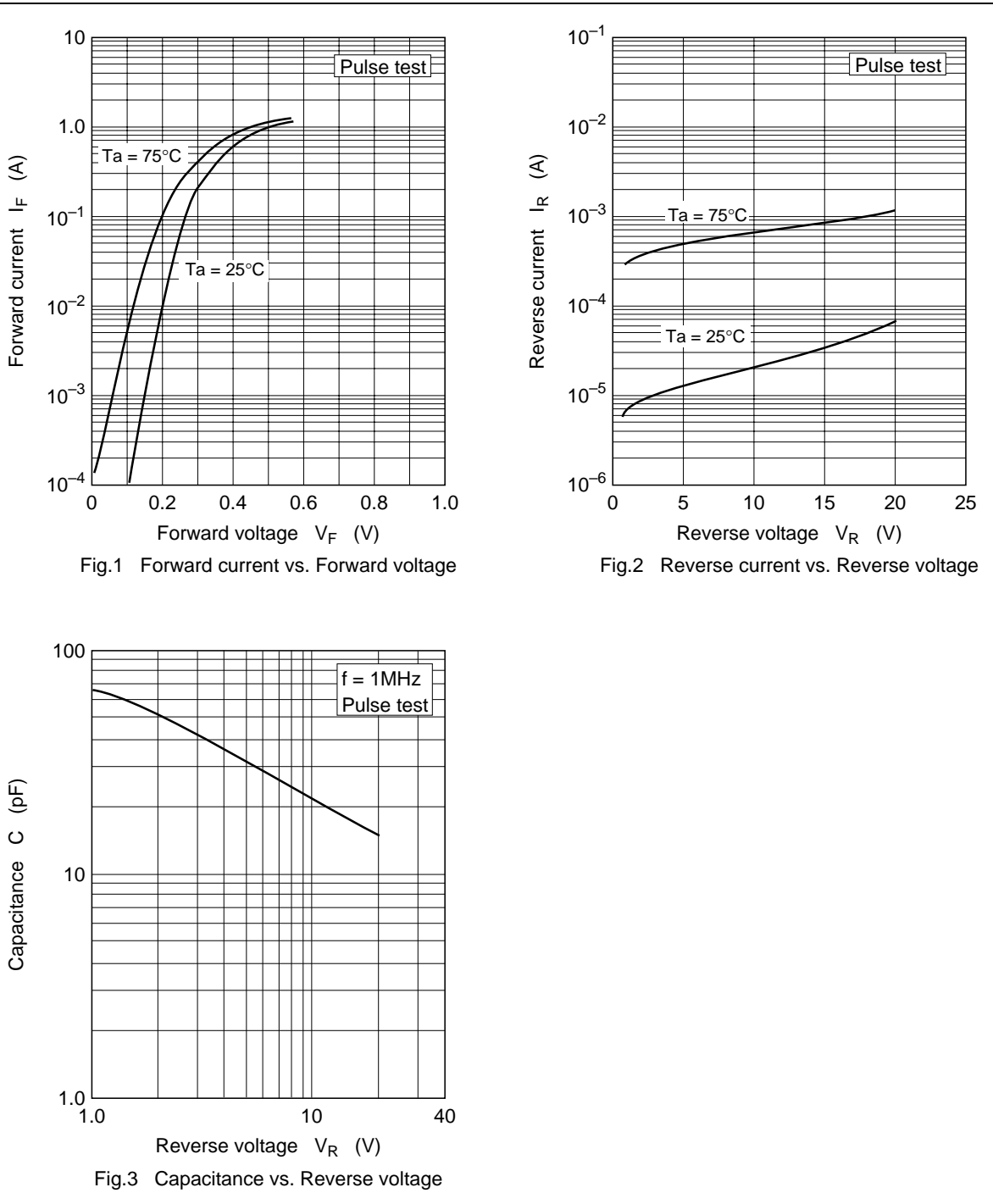
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V_F	—	—	0.4	V	$I_F = 500 \text{ mA}$
Reverse current	I_R	—	—	200	μA	$V_R = 20 \text{ V}$
Capacitance	C	—	120	—	pF	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$
Thermal resistance	$R_{th(j-a)}$	—	340	—	°C/W	Polyimide board ^{*1}

Note: Polyimide board



Main Characteristic



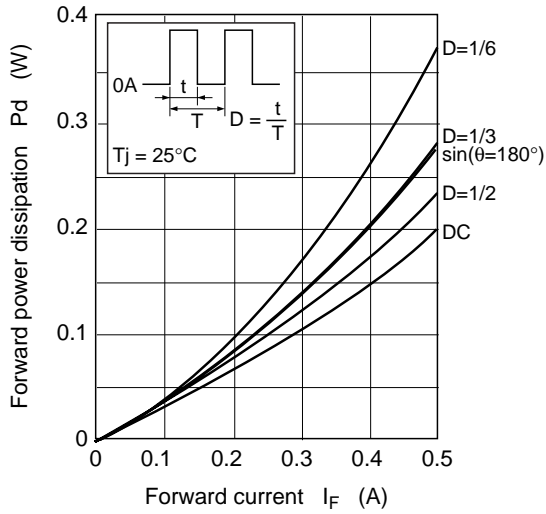


Fig.4 Forward power dissipation vs. Forward current

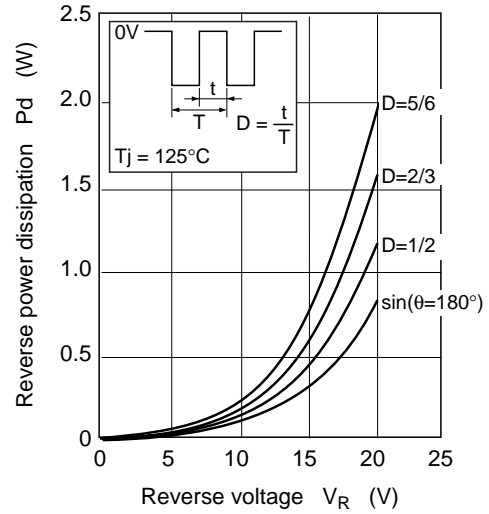


Fig.5 Reverse power dissipation vs. Reverse voltage

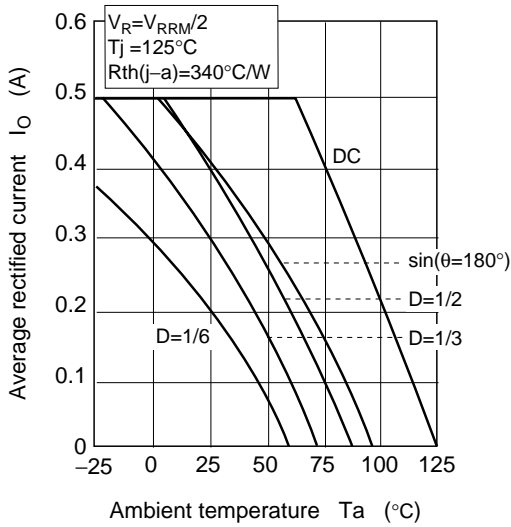
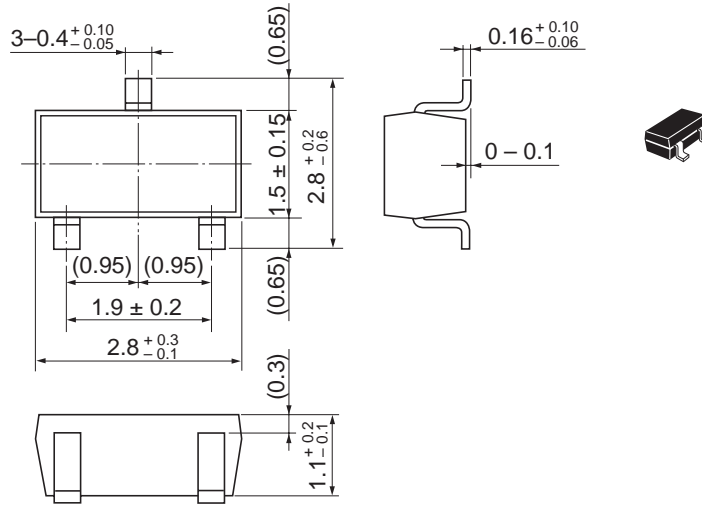


Fig.6 Average rectified current vs. Ambient temperature

Package Dimensions

As of January, 2003
Unit: mm



Package Code	MPAK
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.011 g

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Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, United Kingdom
Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

Renesas Technology Europe GmbH
Dornacher Str. 3, D-85622 Feldkirchen, Germany
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Renesas Technology (Shanghai) Co., Ltd.
26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.
1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001